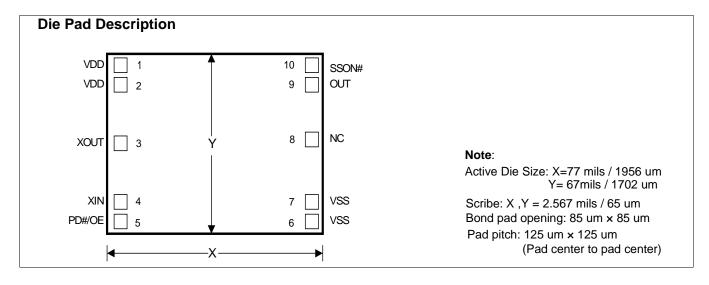
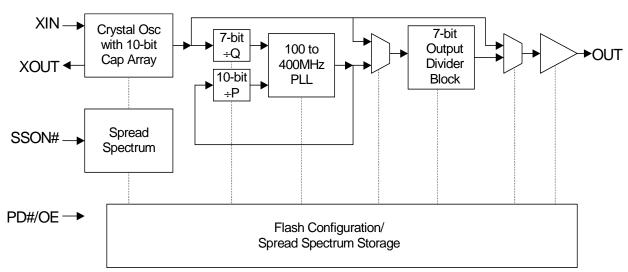


# High-frequency Flash Programmable PLL Die with Spread Spectrum

| Features   | Benefits  |
|--|---|
| Flash-programmable die for in-package programming of crystal oscillators   | Enables quick turnaround of custom oscillators, and lowers inventory costs through stocking blank parts. In addition, the part can be programmed up to 100 times, which reduces programming errors and provides an easy upgrade path for existing designs |
| High-resolution phase-locked loop (PLL) with 10-bit<br>multiplier and seven-bit divider                                  | Enables synthesis of highly accurate and stable output clock frequencies with zero or low PPM   |
| Flash-programmable capacitor tuning array  | Enables fine-tuning of output clock frequency by adjusting $C_{Load}$ of the crystal  |
| Simple two-pin programming interface (excluding V <sub>DD</sub> and V <sub>SS</sub> pins)                                | Allows the device to go into standard four- or six-pin packages.  |
| On-chip oscillator used with external 25.1-MHz fundamental tuned crystal   | Lowers cost of oscillator, as PLL can be programmed to a high frequency using a low-frequency, low-cost crystal   |
| Flash-programmable spread spectrum with eight<br>discrete spread percentages and 30- to 33-kHz<br>modulation frequencies | Provides various spread percentage and modulation frequencies   |
| Spread Spectrum On/Off function  | Provides ability to enable or disable Spread Spectrum with an external pin  |
| Operating frequency     —1–170 MHz at 3.3V ± 10%   | Services most PC, networking, and consumer applications   |
| Seven-bit linear post divider with divide options from divide-by-2 to divide-by-127                                      | Provides flexibility in output configurations and testing   |
| Programmable PD# or OE pin   | Enables low-power operation or output enable function   |
| Programmable asynchronous or synchronous OE and<br>PD# modes   | Provides flexibility for system applications, through selectable instantaneous or synchronous change in outputs   |
| <ul> <li>Low jitter outputs</li> <li>&lt; 200 ps (pk-pk) at 3.3V ± 10%</li> </ul>  | Suitable for most PC, consumer, and networking applications   |
| Controlled rise and fall times and output slew rate  | Has lower EMI than oscillators  |







# **Die Pad Summary**

| Name   | Die Pad | Description   |
|--------|---------|---|
| VDD    | 1,2     | Power supply  |
| VSS    | 6,7     | Ground  |
| XIN    | 4       | Crystal gate pin  |
| XOUT   | 3       | Crystal drain pin   |
| PD#/OE | 5       | Flash-programmable to function as power down or output enable. Acts as the VPP (super voltage) input and data pin in programming mode. There is an internal pull-up resistor on this pin.   |
| SSON#  | 10      | Active LOW Spread Spectrum control. Asserting LOW turns the internal modulation waveform on. Acts as the clock pin in programming mode. Should be double bonded to the OUT pad for pinouts not using the SSON# function. There is an internal pull-down resistor on this pad. |
| OUT    | 9       | Clock output. There is an internal pull-down resistor on this pad.  |
| NC     | 8       | No connect pin. (Do not connect this pad.)  |

#### **Functional Description**

The CY5057 is a flash-programmable, high-accuracy, PLL-based die designed for the crystal oscillator market. It also contains Spread Spectrum circuitry that can be enabled or disabled with an external pin. The die is packaged with a low-cost 25.1-MHz fundamental tuned crystal in a four- or six-pin through-hole or surface mount package. The oscillator devices can be stocked as blank parts and custom frequencies can be programmed in-package at the last stage before shipping. This enables fast-turn manufacturing of custom and standard crystal oscillators without the need for dedicated, expensive crystals.

The CY5057 contains an on-chip oscillator and unique oscillator tuning circuit for fine-tuning the output frequency. The crystal  $C_{load}$  can be selectively adjusted by programming a set of flash memory bits. This feature can be used to compensate for crystal variations or to obtain a more accurate synthesized frequency.

The CY5057 uses a simple two-pin programming interface excluding the  $V_{SS}$  and  $V_{DD}$  pins. Clock outputs can be generated from 1 MHz to 170 MHz at 3.3V  $\pm$  10% operating voltage. The entire Flash configuration can be reprogrammed multiple times, allowing programmed inventory to be altered or reused.

The CY5057 PLL die has been designed for very high resolution. It has a 10-bit feedback counter multiplier and a seven-bit reference counter divider. This enables the synthesis of highly accurate and stable output clock frequencies with zero or low PPM error. The output of the PLL or the oscillator can be further modified by a seven-bit linear post divider with a total of 126 divider options (2 to 127).

The CY5057 also contains flexible power management controls. These parts include both power-down mode (PD# = 0) and output enable mode (OE = 1). The power-down and output enable modes have an additional setting to determine timing (asynchronous or synchronous) with respect to the output signal.

Controlled rise and fall times, unique output driver circuits, and innovative circuit layout techniques enable the CY5057 to have low jitter and accurate outputs making it suitable for most PC, networking and consumer applications.

The CY5057 also has an additional spread spectrum feature that can be disabled or enabled with an external pin. Please refer to Spread Spectrum section for details.

#### Flash Configuration and Spread Spectrum Storage Block

The following table summarizes the features which are configurable by flash memory bits. Please refer to the "CY5057"



Programming Specification" for programming details. The specification can be obtained from your Cypress factory representative.

| Flash Programmable Features |   |  |  |  |  |
|-----------------------------|---|--|--|--|--|
| Adjust                      | Feedback counter value (P)                            |  |  |  |  |
| Frequency                   | Reference counter value (Q)                           |  |  |  |  |
|                             | Output divider selection                              |  |  |  |  |
|                             | Oscillator Tuning (load capacitance values)           |  |  |  |  |
|                             | Oscillator direct output                              |  |  |  |  |
| Pov                         | ver management mode (OE or PD#)                       |  |  |  |  |
| Power manag                 | Power management timing (synchronous or asynchronous) |  |  |  |  |
|                             | Spread Spectrum                                       |  |  |  |  |

#### **PLL Output Frequency**

The CY5057 contains a high-resolution PLL with a 10-bit multiplier and a seven-bit divider. The output frequency of the PLL is determined by the following formula:

$$\mathsf{F}_{\mathsf{PLL}} = \frac{2 \bullet (\mathsf{PBL} + 4) + \mathsf{Po}}{(\mathsf{QL} + 2)} \bullet \mathsf{F}_{\mathsf{REF}}$$

where  $Q_L$  is the loaded or programmed reference counter value (Q counter),  $P_{BL}$  is the loaded or programmed feedback counter value (P counter), and Po is the P offset bit (can only be 0 or 1). In Spread Spectrum mode, the time-averaged P value is used to calculate the average frequency.

#### **Power Management Features**

The CY5057 contains Flash-programmable PD# (active LOW) and OE (active HIGH) functions. If power-down mode is selected (PD# = 0), the oscillator and PLL are placed in a low supply current standby mode and the output is tri-stated and weakly pulled low. The oscillator and PLL circuits must re-lock when the part leaves Powerdown Mode. If output enable mode is selected (OE = 0), the output is tri-stated and weakly pulled low. In this mode the oscillator and PLL circuits continue to operate, allowing a rapid return to normal operation when the output is enabled.

In addition, the PD# and OE modes can be programmed to occur synchronously or asynchronously with respect to the output signal. When the asynchronous setting is used, the

powerdown or output disable occurs immediately (allowing for logic delays) irrespective of position in the clock cycle. However, when the synchronous setting is used, the part waits for a falling edge at the output before powerdown or output enable signal initiated, thus preventing output glitches. In either asynchronous or synchronous setting, the output is always enabled synchronously by waiting for the next falling edge of the output.

#### **Spread Spectrum**

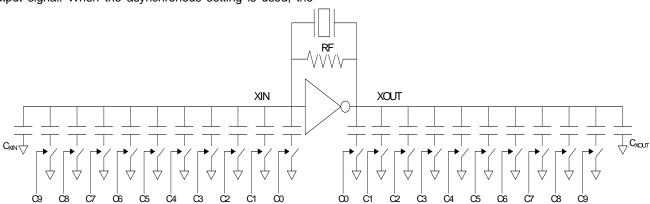
The CY5057 contains spread spectrum with flash programmable spread percentage and modulation frequency. Center spread non-linear "Hershey kiss" style modulation can be obtained. The modulation frequency range is limited from 30 to 33 kHz. Eight discrete levels of spread percentage are delivered.

The CY5057 has a spread spectrum On/Off function. The spread spectrum can be enabled or disabled by users through an external pin. Timing of this feature is shown in "switching waveform" section.

Generic spread spectrum profile programming software is not available to customers at this time. The modulation profiles for the eight discrete spread percentages are given in the "Spread Spectrum Profile" section and will be delivered by the factory.

#### **Crystal Oscillator Tuning Cap Values**

| Bit            | Capacitance per Bit (pF) |
|----------------|--------------------------|
| C <sub>9</sub> | 24.32                    |
| C <sub>8</sub> | 12.16                    |
| C <sub>7</sub> | 6.08                     |
| C <sub>6</sub> | 3.04                     |
| C <sub>5</sub> | 1.52                     |
| C <sub>4</sub> | 0.76                     |
| C <sub>3</sub> | 0.38                     |
|                | 0.19                     |
| C <sub>1</sub> | 0.095                    |
| C <sub>0</sub> | 0.0475                   |



**Figure 1. Crystal Oscillator Tuning Circuit** 



# **Spread Spectrum Profile Tables**

The modulation profile information based on the eight discrete spreads (table below) and 16 nominal output frequencies (table below) will be delivered to customers. The input reference is limited to 25.1 MHz only.

Only one spread profile (for one specific percentage spread and for one output frequency) can be programmed into the device.

| Spread Percentage (Center Spread Only) |
|--|
| <u>+</u> 0.250%                        |
| <u>+</u> 0.500%                        |
| <u>+</u> 0.625%                        |
| <u>+</u> 0.750%                        |
| <u>+</u> 1.00%                         |
| <u>+</u> 1.25%                         |
| <u>+</u> 1.50%                         |
| <u>+</u> 2.00%                         |

| Output Nominal Frequency (Spread On)         |
|--|
| F <sub>nom</sub> = 6.00MHz, Center spread    |
| F <sub>nom</sub> = 20.00MHz, Center spread   |
| F <sub>nom</sub> = 20.75MHz, Center spread   |
| F <sub>nom</sub> = 24.00MHz, Center spread   |
| F <sub>nom</sub> = 24.576MHz, Center spread  |
| F <sub>nom</sub> = 33.00MHz, Center spread   |
| F <sub>nom</sub> = 33.3333MHz, Center spread |
| F <sub>nom</sub> = 50.00MHz, Center spread   |
| F <sub>nom</sub> = 65.7408MHz, Center spread |
| F <sub>nom</sub> = 66.00MHz, Center spread   |
| F <sub>nom</sub> = 66.6666MHz, Center spread |
| F <sub>nom</sub> = 75.00MHz, Center spread   |
| F <sub>nom</sub> = 80.00MHz, Center spread   |
| F <sub>nom</sub> = 100.00MHz, Center spread  |
| F <sub>nom</sub> = 120.00MHz, Center spread  |
| F <sub>nom</sub> = 166.00MHz, Center spread  |



# **Absolute Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.)

Supply Voltage .....-0.5 to +7.0V Input Voltage .....-0.5V to  $V_{DD}$  + 0.5

| Storage Temperature (Non-condensing) –55°C to +125°C                 |
|--|
| Junction Temperature $-40^{\circ}\text{C}$ to $+100^{\circ}\text{C}$ |
| Data Retention @ Tj = 125°C> 10 years                                |
| Maximum Programming Cycles100  |
| Static Discharge Voltage ≥ 2000V (per MIL-STD-883, Method 3015)      |

# **Operating Conditions**

| Parameter           | Description   | Min. | Max.    | Unit |  |
|---------------------|---|------|---------|------|--|
| $V_{DD}$            | Supply Voltage (3.3V)   | 3.0  | 3.0 3.6 | V    |  |
| T <sub>AJ</sub> [1] | Operating Temperature, Junction   | -40  | 100     | °C   |  |
| C <sub>LC</sub>     | Max. Capacitive Load on the output (CMOS levels spec) $V_{DD} = 3.0V - 3.6V$ , output frequency = 1-170 MHz |      | 15      | pF   |  |
| X <sub>REF</sub>    | Reference Frequency with spread spectrum disabled. Fundamental tuned crystals only.                         | 25.1 | 25.1    | MHz  |  |
| C <sub>in</sub>     | Input Capacitance (except crystal pins)   |      | 7       | pF   |  |
| C <sub>XIN</sub>    | Crystal input capacitance (all internal caps off)   | 10   | 14      | pF   |  |
| C <sub>Xout</sub>   | Crystal output capacitance (all internal caps off)  | 10   | 14      | pF   |  |

# DC Electrical Characteristics, Tj = -40 to 100°C

| Parameter           | Description  | Test Conditions  | Min.                  | Max. | Unit     |  |
|---------------------|--|--|-----------------------|------|----------|--|
| V <sub>IL</sub>     | Input Low Voltage CMOS levels, 30% of $V_{DD}$ PD#/OE and SSON# pins $V_{DD} = 3.0V - 3.6V$        |  |                       | 0.3  | $V_{DD}$ |  |
| V <sub>IH</sub>     | Input High Voltage<br>PD#/OE and SSON# pins  |  |                       |      | $V_{DD}$ |  |
| V <sub>OL</sub>     | Output Low voltage, OUT pin  | $V_{DD} = 3.0V - 3.6V, I_{OL} = 8 \text{ mA}$                            |                       | 0.4  | V        |  |
| V <sub>OH</sub>     | Output high voltage, CMOS levels   | $V_{DD} = 3.0V - 3.6V$ , $I_{OH} = -8 \text{ mA}$                        | V <sub>DD</sub> – 0.4 |      | V        |  |
| I <sub>ILPDOE</sub> | Input Low Current, PD#/OE pin  | V <sub>IN</sub> = V <sub>SS</sub><br>(Internal pull-up = 100k typical)   |                       | 50   | μΑ       |  |
| I <sub>IHPDOE</sub> | Input High Current, PD#/OE pin   | V <sub>IN</sub> = V <sub>DD</sub><br>(Internal pull-up = 100k typical)   |                       | 10   | μΑ       |  |
| I <sub>ILSR</sub>   | Input Low Current, SSON# pin V <sub>IN</sub> = V <sub>SS</sub> (Internal pull-down = 100k typical) |  |                       | 10   | μΑ       |  |
| I <sub>IHSR</sub>   | Input High Current, SSON# pin  | V <sub>IN</sub> = V <sub>DD</sub><br>(Internal pull-down = 100k typical) |                       | 50   | μΑ       |  |
| I <sub>DD</sub>     | Supply current   | No Load, V <sub>DD</sub> = 3.0V–3.6V, Fout = 170 MHz                     |                       | 50   | mA       |  |
| l <sub>OZ</sub>     | Output leakage current, OUT pin  | V <sub>DD</sub> = 3.0V–3.6V, Output disabled with OE                     |                       | 50   | μΑ       |  |
| I <sub>PD</sub>     | Stand by current   | $V_{DD}$ = 3.0V–3.6V, Device powered down with PD#                       |                       | 75   | μА       |  |
| R <sub>UP</sub>     | Pull-up resistor on PD#/OE pin   | $V_{DD} = 3.0V - 3.6V$ , measured at $V_{IN} = 0.5V_{DD}$                | 80                    | 150  | kΩ       |  |
| R <sub>DN</sub>     | Pull-down resistor on SSON# and OUT pins   | $V_{DD} = 3.0V - 3.6V$ , measured at $V_{IN} = 0.5V_{DD}$                | 80                    | 150  | kΩ       |  |
| Rf                  | Crystal Feedback Resistor  | V <sub>DD</sub> = 3.0V–3.6V, measured at VDD/2.                          | 200                   |      | kΩ       |  |

#### Note:

<sup>1.</sup> In Cypress standard TSSOP packages with external crystal.



# **AC Electrical Characteristics** $Tj = -40 \text{ to } 100^{\circ}\text{C}$ [1]

| Parameter                      | Description                   | Test Conditions  | Min. | Max.                                   | Unit          |  |
|--------------------------------|-------------------------------|--|------|--|---------------|--|
| F <sub>out</sub>               | Output Frequency              | 15 pF Load, V <sub>DD</sub> = 3.0 to 3.6V  | 1    | 170                                    | MHz           |  |
| tr                             | OUT rise time                 | V <sub>DD</sub> = 3.0V–3.6V, 20% to 80% VDD  |      | 2.7                                    | ns            |  |
| tf                             | OUT fall time                 | VDD = 3.0V-3.6V, 80% to 20% VDD  |      | 2.7                                    | ns            |  |
| DC                             | OUT Duty Cycle                | ·  |      |  |               |  |
| t <sub>J1</sub> <sup>[2]</sup> | Peak to Peak Period<br>Jitter | $F_{out} \ge 133 \text{ MHz}, \text{ VDD/2}, \text{ SS off.}$<br>25 MHz $\le F_{out} < 133 \text{ MHz}, \text{ VDD/2}, \text{ SS off.}$<br>$F_{out} < 25 \text{MHz}, \text{ VDD/2}, \text{ SS off.}$ |      | 200<br>400<br>1% of 1/F <sub>out</sub> | ps<br>ps<br>s |  |
| t <sub>J2</sub> <sup>[2]</sup> | Cycle to Cycle Jitter         | $F_{out}$ >133 MHz, VDD/2, SS on.<br>25MHz $\leq$ $F_{out}$ < 133 MHz, VDD/2, SS on.<br>$F_{out}$ < 25 MHz, VDD/2, SS on.  |      | 200<br>400<br>1% of 1/F <sub>out</sub> | ps<br>ps<br>s |  |
| F <sub>MOD</sub>               | Modulation frequency          |  | 30   | 33                                     | kHz           |  |
| DL                             | Crystal drive level           | Measured at 25.1 MHz, with $20\Omega$ R, $C_{LOAD} = 10$ pF  |      | 150                                    | μW            |  |
| –R                             | Negative Resistance           | Measured at 25.1 MHz   |      | -300                                   | Ω             |  |

# Timing Parameters<sup>[1]</sup>

| Parameter              | Description   | Min. | Max.          | Unit |
|------------------------|---|------|---------------|------|
| T <sub>SSON1</sub>     | Time from steady state spread to steady state non-spread                                  |      | 100           | us   |
| T <sub>SSON2</sub>     | Time from steady state non-spread to steady state spread                                  |      | 100           | us   |
| T <sub>SSON3</sub>     | Minimum SSON# pulse width (positive or negative)  | 250  |               | us   |
| T <sub>MOD</sub>       | Spread Spectrum Modulation period   | 30   | 33.33         | us   |
| T <sub>STP,SYNC</sub>  | Time from falling edge on PD# to stopped outputs, synchronous mode, $T = 1/F_{out}$       |      | T + 350       | ns   |
| T <sub>STP,ASYNC</sub> | Time from falling edge on PD# to stopped outputs, asynchronous mode                       |      | 350           | ns   |
| T <sub>PU,SYNC</sub>   | Time from rising edge on PD# to outputs at valid frequency, synchronous mode              |      | 3             | ms   |
| T <sub>PU,ASYNC</sub>  | Time from rising edge on PD# to outputs at valid frequency, asynchronous mode             |      | 3             | ms   |
| T <sub>PXZ,SYNC</sub>  | Time from falling edge on OE to high-impedance outputs, synchronous mode, $T = 1/F_{out}$ |      | T+350         | ns   |
| T <sub>PXZ,ASYNC</sub> | Time from falling edge on OE to high-impedance outputs, asynchronous mode                 |      | 350           | ns   |
| T <sub>PZX,SYNC</sub>  | Time from rising edge on OE to running outputs, synchronous mode, T=1/F <sub>out</sub>    |      | 1.5T +<br>350 | ns   |
| T <sub>PZX,ASYNC</sub> | Time from rising edge on OE to running outputs, asynchronous mode                         |      | 350           | ns   |
| T <sub>PU</sub>        | Power-up time   |      | 10            | ms   |

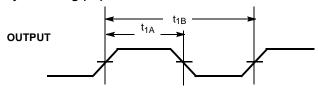
### Notes:

<sup>2.</sup> The jitter spec might be adjusted after the first silicon characterization.



# **Switching Waveforms**

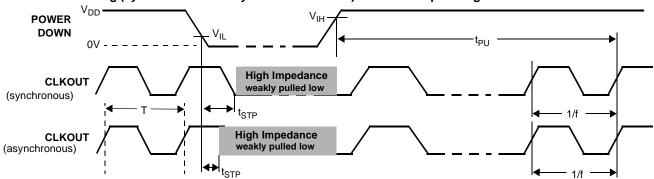
# **Duty Cycle Timing (dc)**



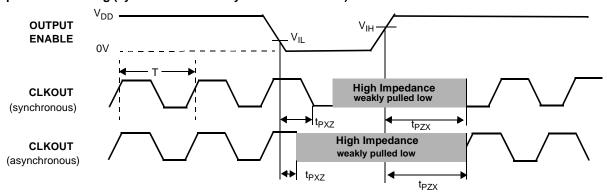
# **Output Rise/Fall Time**



# Power-down Timing (synchronous and asynchronous modes) and Power-up Timing

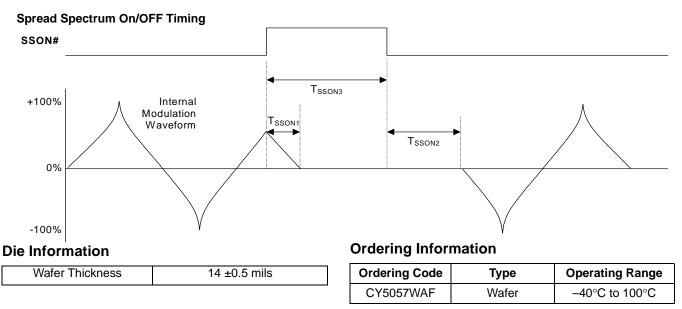


# **Output Enable Timing (synchronous and asynchronous modes)**





# Switching Waveforms (continued)



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| Document Title: CY5057 High-frequency Flash Programmable PLL Die with Spread Spectrum Document Number: 38-07363 |         |               |                    |                       |  |
|---|---------|---------------|--------------------|-----------------------|--|
| REV.  | ECN NO. | Issue<br>Date | Orig. of<br>Change | Description of Change |  |
| **  | 112486  | 05/01/02      | CKN                | New Data Sheet        |  |